

SPP3403**DESCRIPTION**

The SPP3403 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

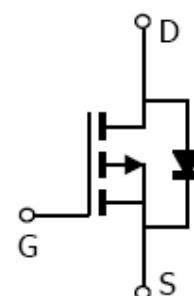
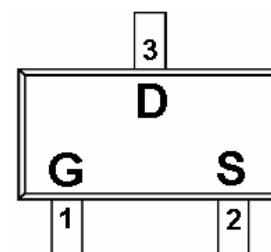
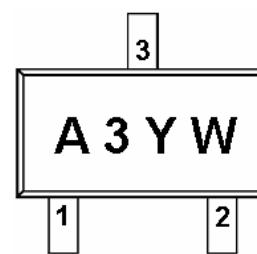
These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

FEATURES

- ◆ -30V/-2.8A,RDS(ON)=100mΩ@VGS=- 10V
- ◆ -30V/-2.5A,RDS(ON)=110mΩ@VGS=-4.5V
- ◆ -30V/-1.5A,RDS(ON)=145mΩ@VGS=-2.5V
- ◆ -30V/-1.0A,RDS(ON)=200mΩ@VGS=-1.8V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-3L package design

PIN CONFIGURATION (SOT-23-3L)**PART MARKING**

Y : Year Code
W : Week Code

SPP3403

PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP3403S23RG	SOT-23-3L	A3YW
SPP3403S23RGB	SOT-23-3L	A3YW

- ※ Week Code : A ~ Z(1 ~ 26) ; a ~ z(27 ~ 52)
- ※ SPP3403S23RG : Tape Reel ; Pb – Free
- ※ SPP3403S23RGB : Tape Reel ; Pb – Free ; Halogen – Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-30	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	-3.5	A
	T _A =70°C		
Pulsed Drain Current	I _{DM}	-20	A
Continuous Source Current(Diode Conduction)	I _S	-1.4	A
Power Dissipation	T _A =25°C	1.25	W
	T _A =70°C		
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W

SPP3403
ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=-250uA	-30			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=-250uA	-0.4		-1.0	
Gate Leakage Current	IGSS	VDS=0V, VGS=±12V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=-24V, VGS=0V			-1	uA
		VDS=-24V, VGS=0V TJ=85°C			-5	
On-State Drain Current	ID(on)	VDS= -5V, VGS =-4.5V	-4			A
Drain-Source On-Resistance	RDS(on)	VGS=-10V, ID=-2.8A		0.080	0.100	Ω
		VGS=-4.5V, ID=-2.5A		0.100	0.110	
		VGS=-2.5V, ID=-1.5A		0.130	0.145	
		VGS=-1.8V, ID=-1.0A		0.160	0.200	
Forward Transconductance	gfs	VDS=-10V, ID=-2.8A		4		S
Diode Forward Voltage	VSD	IS=-1.2A, VGS =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Qg	VDS=-15V , VGS=-4.5V ID=-2.0A		5.8		nC
Gate-Source Charge	Qgs			0.8		
Gate-Drain Charge	Qgd			1.5		
Input Capacitance	Ciss	VDS=-15V , VGS=0V f=1MHz		380		pF
Output Capacitance	Coss			55		
Reverse Transfer Capacitance	Crss			40		
Turn-On Time	td(on)	VDD=-15V , RL=15Ω ID=-1.0A , VGEN=-10V RG=3Ω		6		ns
	tr			3.9		
Turn-Off Time	td(off)			40		
	tf			15		